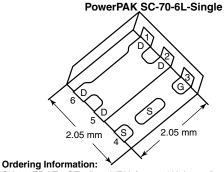
Vishay Siliconix

SiA453EDJ



P-Channel 30 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | |
|---------------------|-------------------------------------|---------------------------------|-----------------------|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) (Max.) | I _D (A) ^a | Q _g (Typ.) | | |
| - 30 | 0.0185 at V _{GS} = - 10 V | - 24 | | | |
| | 0.0235 at V _{GS} = - 4.5 V | - 21 | 21 nC | | |
| | 0.0260 at V _{GS} = - 3.7 V | - 20 | 21110 | | |
| | 0.0377 at V _{GS} = - 2.5 V | - 10 | | | |



SiA453EDJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- TrenchFET[®] Power MOSFET
- Thermally Enhanced PowerPAK[®] SC-70 Package - Small Footprint Area
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 - Low On-Resistance
- 100 % R_g and UIS Tested
- Typical ESD Protection: 4000 V (HBM)
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Lot Traceability

and Date code

APPLICATIONS

- Portable Devices such as Smart Phones, Tablet PCs and Mobile Computing
 - Load Switch

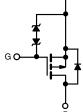
Part # code

- Power Management
- Input Protection Switch (over voltage, reverse voltage)

Marking Code

B2X

• X X X



HALOGEN

FREE

P-Channel MOSFET

| Parameter | Symbol | Limit | Unit | | |
|--|------------------------|-----------------------------------|-----------------------|-----|--|
| Drain-Source Voltage | | V _{DS} | - 30 | - v | |
| Gate-Source Voltage | | V _{GS} | ± 12 | | |
| | T _C = 25 °C | | - 24 | | |
| Continuous Drain Current (T 150 °C) | T _C = 70 °C | Ι.Γ | - 19 | | |
| Continuous Drain Current ($T_J = 150 \ ^{\circ}C$) | T _A = 25 °C | I _D | - 10 ^{b, c} | | |
| | T _A = 70 °C | Γ | - 8 ^{b, c} | | |
| Pulsed Drain Current (t = 100 µs) | | I _{DM} | - 80 | — A | |
| Continuous Source-Drain Diode Current | T _C = 25 °C | | - 16 | | |
| | T _A = 25 °C | I _S | - 2.9 ^{b, c} | | |
| Single Avalanche Current | L = 0.1 mH | I _{AS} | - 10 | | |
| Single Avalanche Energy | L = 0.1 MH | E _{AS} | 5 | mJ | |
| | T _C = 25 °C | | 19 | W | |
| Maximum Power Dissipation | T _C = 70 °C | | 12 | | |
| | T _A = 25 °C | P _D | 3.5 ^{b, c} | vv | |
| | T _A = 70 °C | | 2.2 ^{b, c} | 1 | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 50 to 150 | °C | |
| Soldering Recommendations (Peak Temperature) ^{d, e} | | | 260 | -0 | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|---|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^{b, f} | t ≤ 5 s | R _{thJA} | 28 | 36 | °C/W | |
| Maximum Junction-to-Case (Drain) | Steady State | R _{thJC} | 5.3 | 6.5 | C/W | |

Notes

a. T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 80 °C/W.

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SiA453EDJ

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|--|-------------------------|--|-------|--------|--------|-------|--|
| Static | | | | • | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$ | - 30 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_J$ | L 050 A | | - 21 | | mV/°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = - 250 μA | | 3.1 | | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$ | - 0.6 | | - 1.4 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 12 V$ | | | ± 4 | | |
| | | $V_{DS} = 0 V, V_{GS} = \pm 4.5 V$ | | | ± 0.5 | | |
| | I _{DSS} | $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$ | | | - 1 | μA | |
| Zero Gate Voltage Drain Current | | V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C | | | - 10 | - | |
| On-State Drain Currenta | I _{D(on)} | $V_{DS} \le -5 V$, $V_{GS} = -10 V$ | - 10 | | | А | |
| Drain-Source On-State Resistance ^a | | V _{GS} = - 10 V, I _D = - 5 A | | 0.0150 | 0.0185 | | |
| | | V _{GS} = - 4.5 V, I _D = - 5 A | | 0.0185 | 0.0235 | Ω | |
| | R _{DS(on)} | V _{GS} = - 3.7 V, I _D = - 5 A | | 0.0205 | 0.0260 | | |
| | | V _{GS} = - 2.5 V, I _D = - 2 A | | 0.0290 | 0.0377 | | |
| Forward Transconductance ^a | g _{fs} | V _{GS} = - 15 V, I _D = - 5 A | | 22 | | S | |
| Dynamic ^b | 010 | | | • | | | |
| ut Capacitance C _{iss} | | | 1900 | | | | |
| Output Capacitance | C _{oss} | V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz | | 160 | | pF | |
| Reverse Transfer Capacitance | C _{rss} | | | 145 | | | |
| | | V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 11 A | | 44 | 66 | 1 | |
| Total Gate Charge | | | | 21 | 32 | nC | |
| Gate-Source Charge | Q _{gs} | V _{DS} = - 15 V, V _{GS} = - 4.5 V, I _D = - 11 A | | 3.9 | | | |
| Gate-Drain Charge | Q _{qd} | | | 5.9 | | | |
| Gate Resistance | Ra | f = 1 MHz | 1.8 | 9 | 18 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 25 | 50 | | |
| Rise Time | t _r | V _{DD} = - 15 V, R _I = 1.7 Ω | | 45 | 90 | - | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong -9$ A, $V_{GEN} = -4.5$ V, $R_g = 1 \Omega$ | | 65 | 130 | | |
| Fall Time | t _f | | | 28 | 55 | | |
| Turn-On Delay Time | t _{d(on)} | | | 10 | 20 | ns | |
| Rise Time | t _r | $V_{DD} = -15 \text{ V}, \text{ R}_{\text{I}} = 1.7 \Omega$ | | 5 | 10 | 1 | |
| Turn-Off Delay Time | t _{d(off)} | | | 90 | 180 | 1 | |
| Fall Time | t _f | | | 25 | 50 | 1 | |
| Drain-Source Body Diode Characteristi | | | | | | | |
| Continuous Source-Drain Diode Current | Is | T _C = 25 °C | | | - 16 | | |
| Pulse Diode Forward Current (t = 100 µs) | I _{SM} | ~ • • | | | - 80 | A | |
| Body Diode Voltage | V _{SD} | I _S = - 9 A, V _{GS} = 0 V | | - 0.85 | - 1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 22 | 45 | ns | |
| Body Diode Reverse Recovery Charge Q _{rr} | | 4 | | 20 | 40 | nC | |
| Reverse Recovery Fall Time | t _a | I_F = - 9 A, dl/dt = 100 A/µs, T _J = 25 °C | | 16 | | + | |
| Reverse Recovery Rise Time | t _b | | | 6 | | ns | |

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

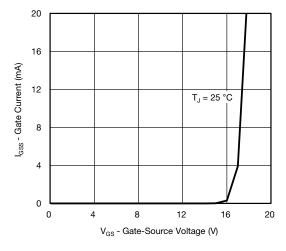
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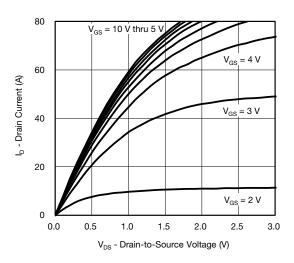


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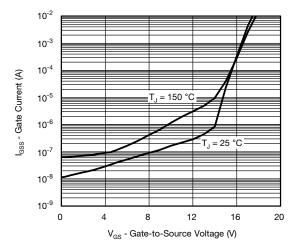
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



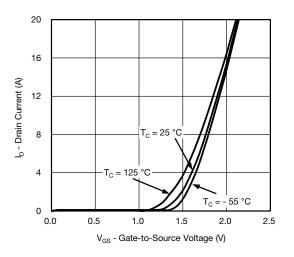
Gate Current vs. Gate-Source Voltage



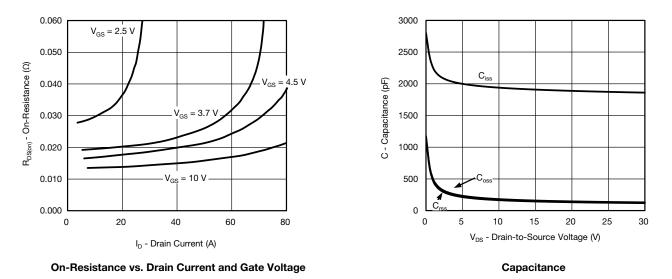
Output Characteristics



Gate Current vs. Gate-to-Source Voltage







S13-1271-Rev. A, 27-May-13

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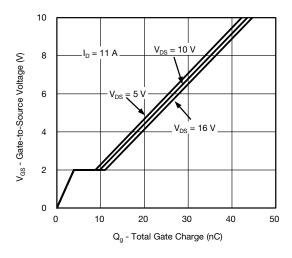
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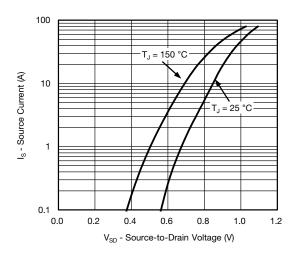
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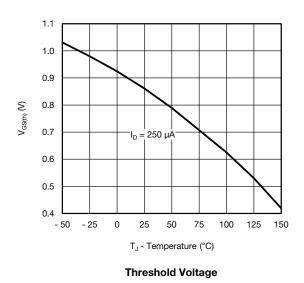
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

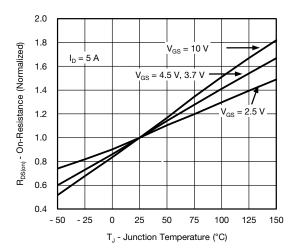


Gate Charge

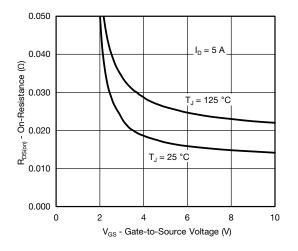


Soure-Drain Diode Forward Voltage

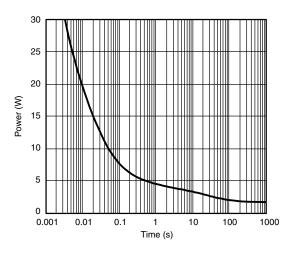




On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

S13-1271-Rev. A, 27-May-13

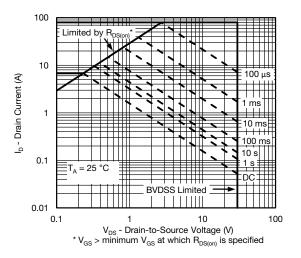
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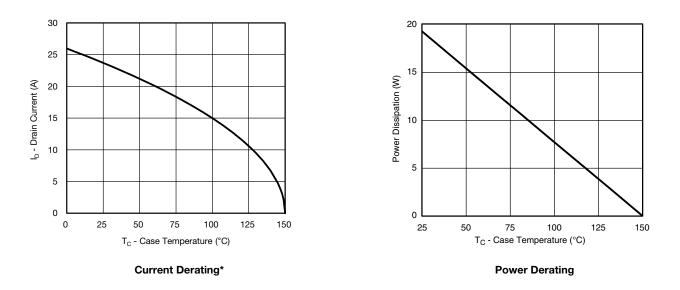


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient



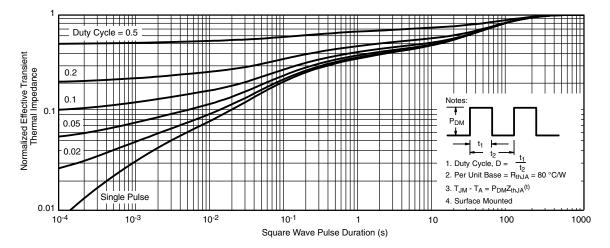
* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



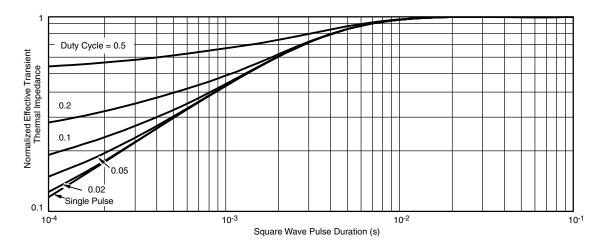
SiA453EDJ

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



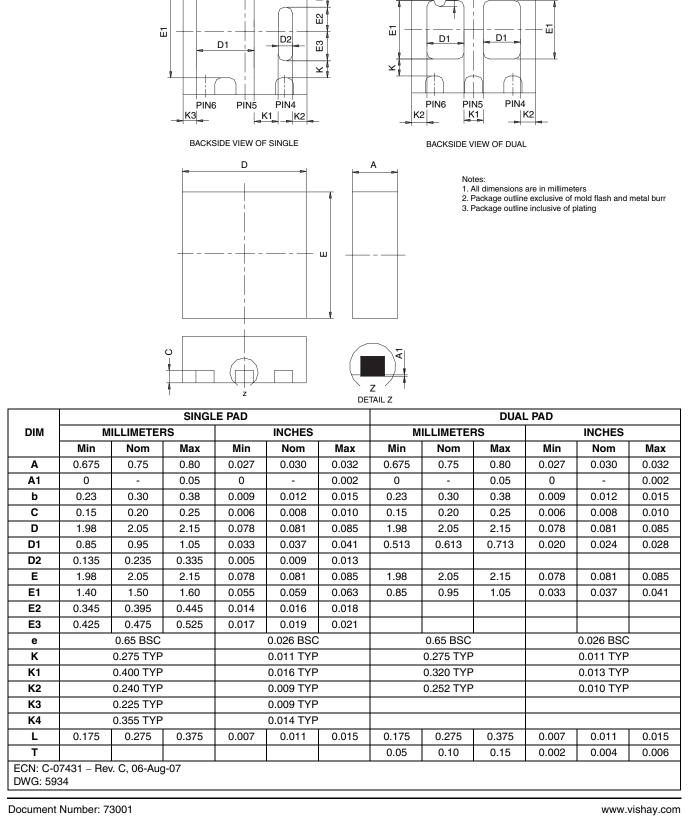
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62864

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PowerPAK[®] SC70-6L

b PIN2 PIN1 PIN3 _ ₹

Package Information Vishay Siliconix

_ ₿

b

PIN3

PIN2

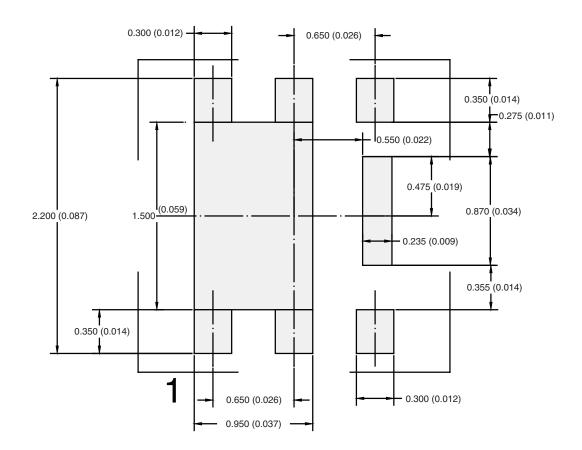
PIN1

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VISHA



RECOMMENDED PAD LAYOUT FOR PowerPAK[®] SC70-6L Single



Dimensions in mm/(Inches)

Return to Index



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